

Constant On-Time Buck Converter with Integrated Linear Regulator

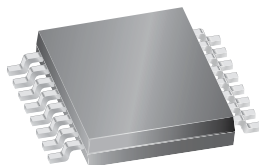
Features and Benefits

- 2 MHz switching frequency
- Adjustable soft start timer
- Watchdog input
- Power-on reset output
- Adjustable 2% buck regulator
- Adjustable 2% linear regulator
- Enable input
- 6 to 50 V supply voltage range
- Overcurrent protection
- Undervoltage lockout (UVLO)
- Thermal shutdown protection

Applications:

- Photo and inkjet printers
- Industrial controls
- Distributed power systems
- Network applications

Package: 16-pin TSSOP with exposed thermal pad (suffix LP)



Not to scale

Description

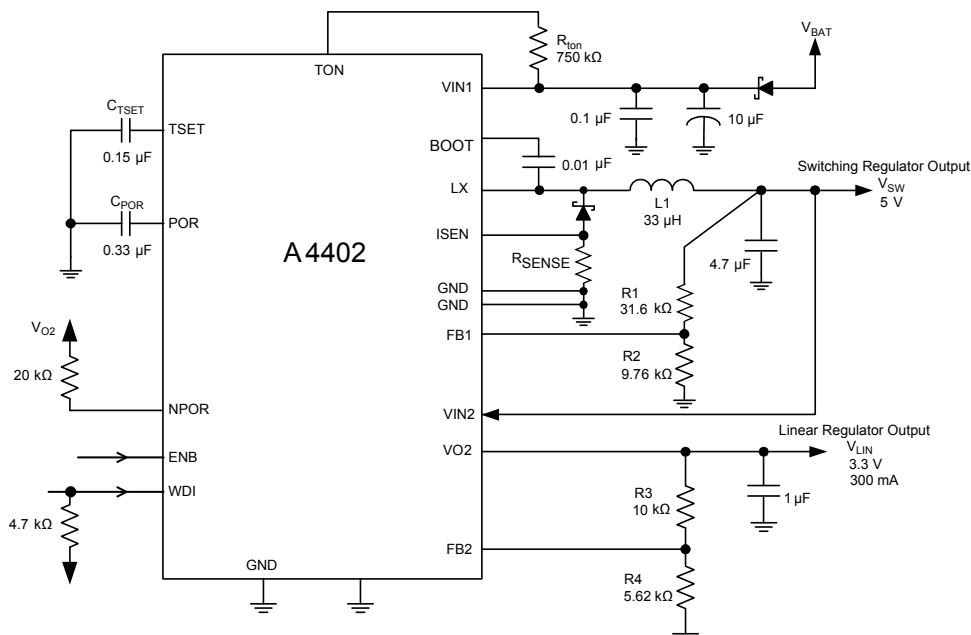
The A4402 is a power management IC that combines a 2% constant on-time buck regulator and a 2% linear regulator. Ideal for applications that require two regulated voltages. The buck regulator output supplies the adjustable linear regulator to reduce power dissipation and increase overall efficiency.

The switching regulator is capable of operating above 2 MHz. A greater than 2 MHz switching frequency enables the customer to select low value inductors and capacitors while avoiding EMI.

Protection features include undervoltage lockout and thermal shutdown. In case of a shorted load, each regulator features overcurrent protection. The A4402 also features a power-on reset with adjustable delay for the microprocessor output.

The A4402 is provided in a 16-pin, ≤ 1.20 mm nominal overall height TSSOP, with exposed pad for enhanced thermal dissipation. It is lead (Pb) free, with 100% matte tin leadframe plating.

Typical Application



Selection Guide

Part Number	Packing	Package
A4402ELPTR-T	4000 pieces per 13-in. reel	16-pin TSSOP with exposed thermal pad

Absolute Maximum Ratings

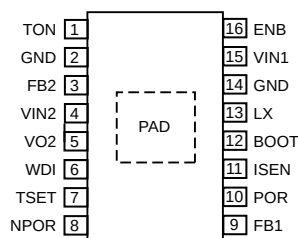
Characteristic	Symbol	Notes	Rating	Units
VIN1 Pin	V_{IN1}		−0.3 to 50	V
VIN2 Pin	V_{IN2}		−0.3 to 7	V
LX Pin	V_{LX}		−1 to 50	V
ISEN Pin	V_{ISEN}		−0.5 to 1	V
ENB Pin	V_{ENB}		−0.3 to 7	V
VO2 Pin	V_{O2}		−0.3 to 7	V
WDI Pin	V_{WDI}		−0.3 to 6	V
TON Pin	V_{TON}		−0.3 to 7	V
FB1 and FB2 Pins	V_{FBx}		−0.3 to 7	V
NPOR	V_{NPOR}		−0.3 to 6.5	V
Ambient Operating Temperature	T_A	Range E	−40 to 85	°C
Junction Temperature	$T_{j(max)}$		150	°C
Storage Temperature Range	T_{stg}		−40 to 150	°C

Thermal Characteristics

Characteristic	Symbol	Test Conditions*	Value	Units
Package Thermal Resistance	$R_{\theta JA}$	On 4-layer PCB based on JEDEC standard	34	°C/W

*Additional thermal information available on the Allegro website.

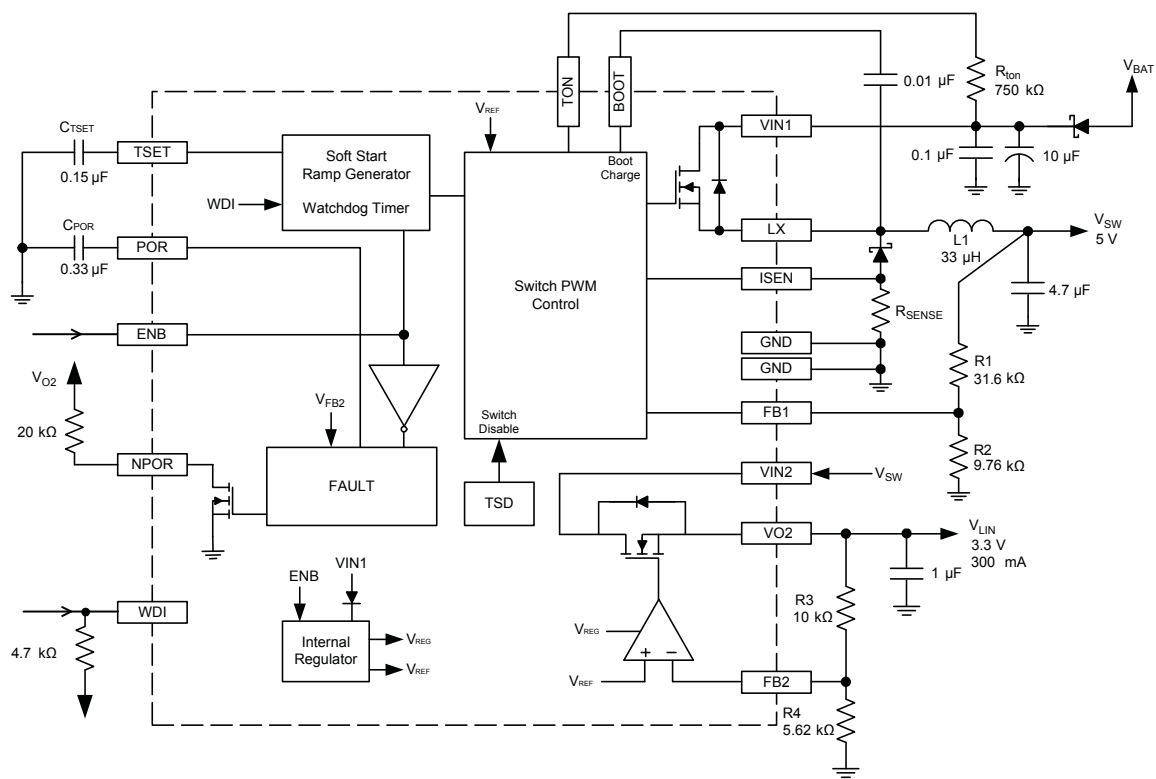
Pin-out Diagram



Terminal List Table

Number	Name	Function
1	TON	On time setting terminal
2	GND	Ground
3	FB2	Feedback for V_{LIN}
4	VIN2	Input voltage 2
5	VO2	Regulator 2 output
6	WDI	Watchdog input
7	TSET	Soft start and watchdog timing capacitor terminal
8	NPOR	Fault output
9	FB1	Feedback for V_{SW}
10	POR	POR delay
11	ISEN	Current sense, limit setting for switching regulator, connect to GND through series resistor
12	BOOT	Boot node for LX
13	LX	Switching regulator output
14	GND	Ground
15	VIN1	Input voltage 1
16	ENB	Enable input
–	PAD	Exposed thermal pad

Functional Block Diagram



ELECTRICAL CHARACTERISTICS^{1,2} valid at $T_J = 25^\circ\text{C}$, $V_{IN} = 13.5\text{ V}$ (unless otherwise noted)

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Voltage Supply 1	V _{IN1}		6	13.5	50	V
Input Voltage Supply 2	V _{IN2}	V _{IN2} = V _{SW}	3.3	–	5	V
Supply Quiescent Current	I _{IN(Q)}	ENB = 5 V, I _{OUT} = I _{SW} + I _{LIN} = 0 mA, V _{IN} = 13.5 V	–	10	–	mA
		V _{IN1} = 13.5 V, ENB = 0 V, I _{OUT} = I _{SW} + I _{LIN} = 0 mA	–	–	2	μA
ENB Logic Input Voltage	V _{ENB}	V _{ENB} rising	2.0	2.28	2.56	V
ENB Hysteresis	V _{ENBHYS}		–	100	–	mV
ENB Logic Input Current	I _{ENB}	High input level, V _{ENB} = 3 V	–	–	100	μA
		Low input level, V _{ENB} < 0.4 V	–2	–	2	μA
Linear Regulator						
Output Voltage Range	V _{O2}		1.8	–	3.3	V
Feedback Voltage	V _{FB2}	1 mA < I _{O2} < 250 mA, 3.3 V < V _{IN2} < 5 V	1.156	1.180	1.204	V
V _{O2} Undervoltage Lockout Threshold	V _{O2UVLO}	V _{O2} rising based on FB voltage	0.896	0.944	0.990	V
V _{O2} Undervoltage Lockout Hysteresis	V _{O2UVHYS}		30	50	70	mV
Feedback Input Bias Current	I _{FB2}		–100	100	400	nA
Current Limit	I _{O2}		250	–	350	mA
Dropout Voltage	V _{DROP}	I _{OUT} = I _{SW} + I _{LIN} = 250 mA	–	–	1.2	V
Switching Regulator						
Output Voltage Range	V _{SW}		3.3	–	5	V
Feedback Voltage	V _{FB1}	I _{OUT} = I _{SW} + I _{LIN} = 1 mA to 1.0 A, 8 V < V _{IN} < 18 V	1.156	1.180	1.204	V
Feedback Input Bias Current	I _{FB1}		–400	–100	100	nA
Switcher On Time	t _{on}	V _{IN} = 19.25 V, R _{ton} = 750 kΩ	–	670	–	ns
		V _{IN} = 13.5 V, R _{ton} = 750 kΩ	185	235	285	ns
		V _{IN} = 8 V, R _{ton} = 750 kΩ	–	1.4	–	μs
t _{on} Low Voltage Threshold	V _{PL}	V _{IN} rising	8.1	9	9.9	V
t _{on} High Voltage Threshold	V _{PH}	V _{IN} rising	15.75	17.5	19.25	V
Changeover Hysteresis	V _{HYS}		–	250	–	mV
On-time Accuracy	err _{ton}		–30	–	30	%
Minimum On-time	t _{onmin}		80	–	–	ns
Minimum Off-time	t _{offmin}		130	–	–	ns
Buck Switch On-Resistance	R _{DS(on)}	T _J = 25°C, I _{LOAD} = 1 A	–	400	–	mΩ
		T _J = 125°C, I _{LOAD} = 1 A	–	650	–	mΩ
ISEN Voltage	V _{ISEN}		–	–200	–	mV
Valley Current Limit Threshold	I _{lim}	R _{SENSE} = 0.27 Ω	–	740	–	mA
		6 V < V _{IN} < 8 V	–	–	550	mA

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ELECTRICAL CHARACTERISTICS^{1,2} (continued) valid at $T_J = 25^\circ\text{C}$, $V_{IN} = 13.5\text{ V}$ (unless otherwise noted)

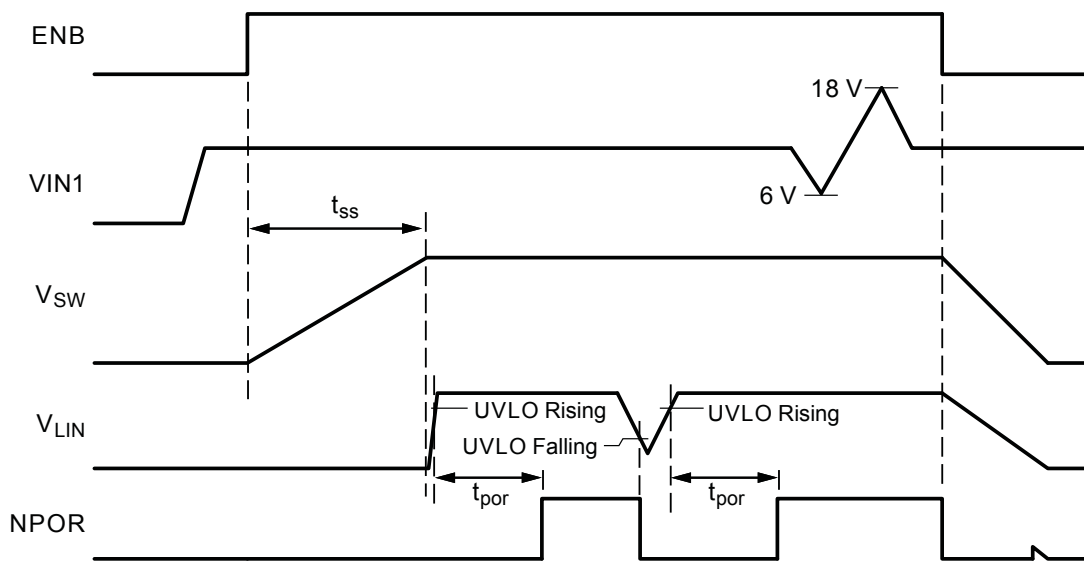
Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Protection Circuitry						
NPOR Output Voltage	V_{NPOR}	$I_{NPOR} = 1\text{ mA}$	–	–	400	mV
NPOR Leakage Current	I_{NPOR}	$V_{NPOR} = 5\text{ V}$	–	–	1	μA
NPOR Reset	$V_{NPORRESET}$	20 k Ω pullup connected to VOUT2, $V_{IN} <$	–	–	0.7	V
Thermal Shutdown Threshold	T_{JTSD}	T_J rising	–	170	–	$^\circ\text{C}$
Thermal Shutdown Hysteresis	$T_{JTSDHYS}$		–	15	–	$^\circ\text{C}$
Timing Circuitry						
TSET Current, Watchdog Mode	$I_{TSETWDI}$	NPOR = high	7	10	14	μA
TSET Valley Voltage, Watchdog Mode	V_{TRIP}		–	1.2	–	V
TSET Reset Voltage, Watchdog Mode	V_{RESET}		–	0.48	–	V
WDI Frequency	f_{WDI}		–	–	100	kHz
WDI Duty Cycle	DC_{WDI}		10	–	90	%
WDI Logic Input	$V_{WDI(0)}$		$V_{IN2} \times 0.55$	–	–	V
WDI Logic Input Current	I_{WDI}	$V_{WDI} = 0\text{ to }5\text{ V}$	–20	< 1.0	20	μA
WDI Input Hysteresis	V_{WDIHYS}		–	300	–	mV
TSET Current, Soft Start Mode	I_{TSETSS}	NPOR = low	14	20	26	μA
POR Current	I_{POR}		3.92	5.60	7.28	μA

¹For input and output current specifications, negative current is defined as coming out of (sourcing) the specified pin.

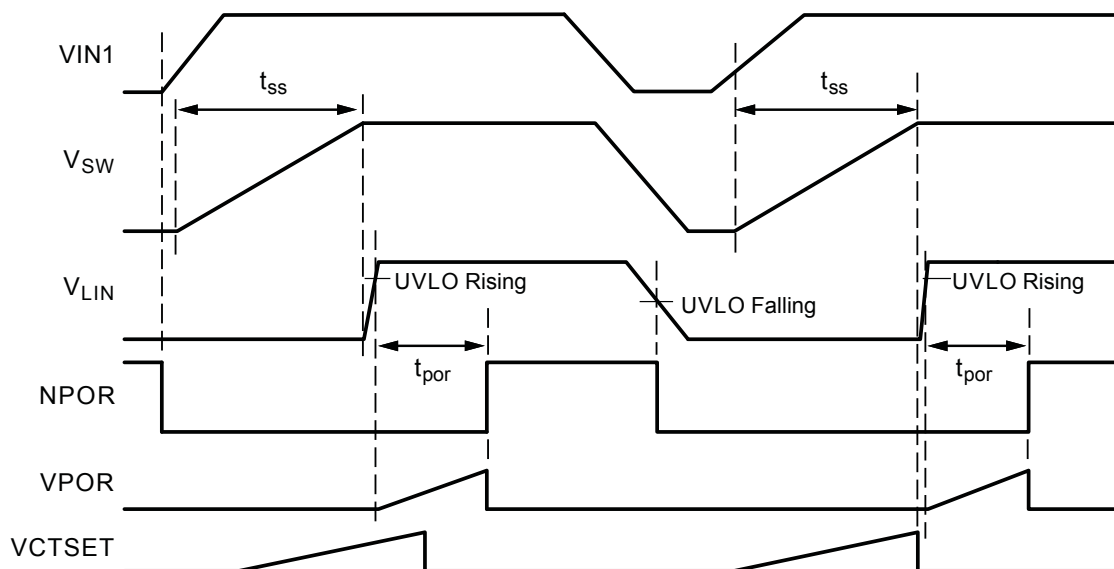
²Performance in the range -40°C to 85°C guaranteed by design and characterization.

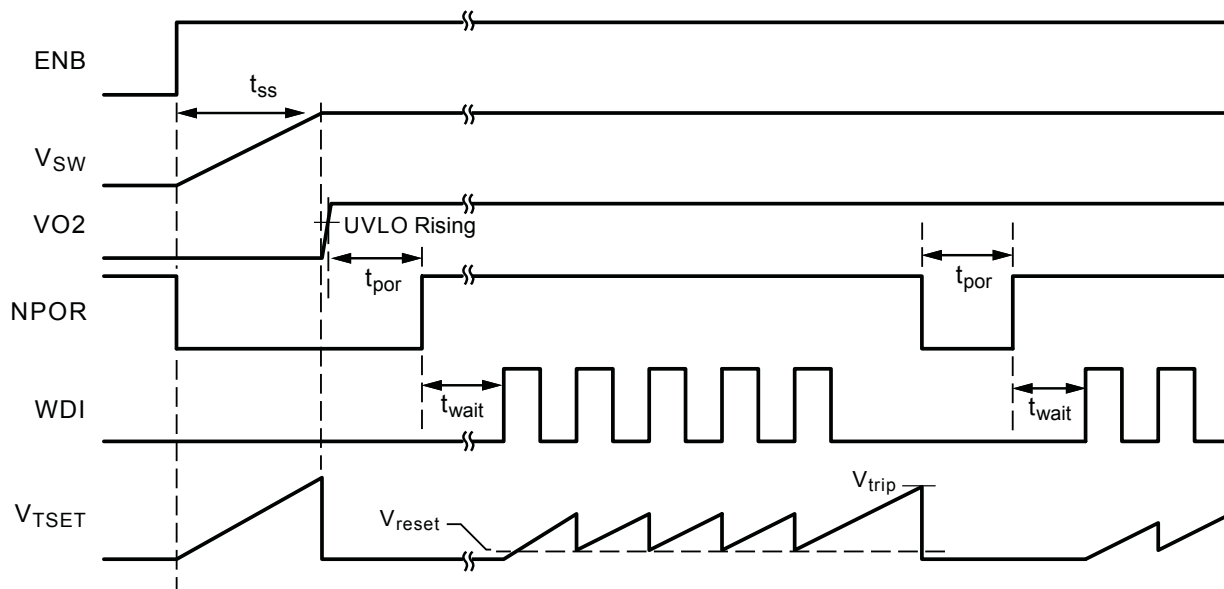
Power-Up and Power-Down Timing Diagrams

Using ENB



Using VIN1



Watchdog Timing Diagram

Functional Description

Basic Operation The A4402 contains a fixed on-time, adjustable voltage buck switching regulator with valley sensing current mode control, and an adjustable linear regulator designed to run off the buck regulator output. The constant on-time converter maintains a constant output frequency because the on-time is inversely proportional to the supply voltage. As the input voltage decreases, the on-time is increased, maintaining a relatively constant period. Valley mode current control allows the converter to achieve very short on-times because current is measured during the off-time.

The device is enabled via the ENB input. When the ENB pin is pulled high, the converter starts-up under the control of an adjustable soft start routine whose ramp time is controlled by an external capacitor.

Under light load conditions, the switch enters pulse-skipping mode to ensure regulation is maintained. This effectively changes the switcher frequency. The frequency also is affected when the switcher is operating in discontinuous mode. In order to maintain a wide input voltage range, the switcher period is extended when either the minimum off-time at low V_{IN} , is reached or the minimum on-time at high V_{IN} .

Switcher Overcurrent Protection The converter utilizes pulse-by-pulse valley current limiting, which operates when the current through the sense resistor creates a voltage on the sense pin (ISEN) that equals -0.2 V. During an overload condition, the switch is turned on for a period determined by the constant on-time circuitry. The switch off-time is extended until the current decays to the current limit value set by the selection of the sense resistor, at which point the switch turns on again. Because no slope compensation is required in this control scheme, the current limit is maintained at a reasonably constant level across the input voltage range.

Figure 1 illustrates how the current is limited during an overload condition. The current decay (period with switch off) is proportional to the output voltage. As the overload is increased, the output voltage tends to decrease and the switching period increases.

VIN1 and VIN2 VIN1 is a high voltage input, designed to withstand 50 V. Bulk capacitance of at least 10 μ F should be used to

decouple input supply VIN1. The VIN2 input is used to supply the linear regulator and should be connected directly to the output of the switching regulator.

Output Voltage Selection The output voltage on each of the two regulators is set by a voltage divider off the regulator output, as follows:

$$V_{SW} = V_{FB1} \left(\frac{R1 + R2}{R2} \right) ,$$

$$V_{LIN} = V_{FB2} \left(\frac{R1 + R2}{R2} \right) . \quad (1)$$

In order to maintain accuracy on the regulators the equivalent impedance on the FB node ($R1$ parallel with $R2$) should be approximately 10 k Ω .

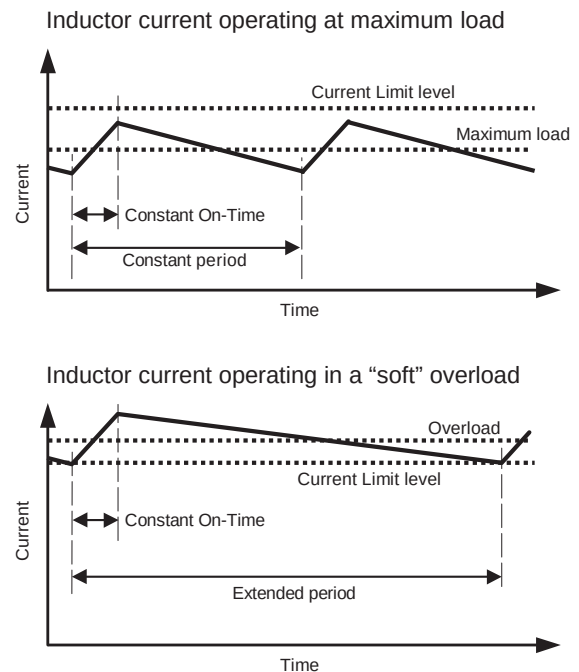


Figure 1. Current limiting during overload

TSET The TSET pin serves a dual function by controlling the timing for both the soft start ramp and the WDI input. The current sourced from the TSET pin is dependant on the state of NPOR.

There are two formulas for calculating the time constants. C_{TSET} must be selected so that both the WDI frequency and soft start requirements are met. The formulas for calculating WDI and soft start timing are:

$$t_{WDI} = 7.2 \times 9.6 \times 10^4 \times C_{TSET} \quad , \quad \text{and} \quad (2)$$

$$t_{SS} = 6.0 \times 6.0 \times 10^4 \times C_{TSET} \quad , \quad (3)$$

where C_{TSET} is the value of the capacitor and the results, t_x , are in s.

Watchdog The WDI input is used to monitor the state of a DSP or microcontroller. A constant current is driven into the capacitor on TSET, causing the voltage on the TSET pin to ramp upward until, at each rising edge on the WDI input, the ramp is pulled down to V_{RESET} . If no edge is seen on the WDI pin before the ramp reaches V_{TRIP} , the NPOR pin is pulled low.

The watchdog timer is not activated until the WDI input sees one rising edge. The WDI pin should be pulled to ground with a 4.7 kΩ resistor.

Soft Start During soft start, an internal ramp generator and the external capacitor on TSET are used to ramp the output voltage in a controlled fashion. This reduces the demand on the external power supply by limiting the current that charges the output capacitor and any DC load at startup. Either of the following conditions are required to trigger a soft start:

- ENB pin input rising edge
- Reset of a TSD event

When a soft start event occurs, VO2 is held in the off state until the soft start ramp timer expires. Then the regulator will power up normally. Refer to timing diagrams for details.

BOOT A bootstrap capacitor is used to provide adequate charge to the NMOS switch. The boot capacitor is referenced to LX and supplies the gate drive with a voltage larger than the supply voltage. The size of the capacitor must be 0.01 μF, X7R type, and rated for at least 25 V.

TON A resistor from the TON input to VIN1 sets the on-time of the converter for a given input voltage. The formula to calculate the on-time is:

$$t_{on} = \frac{R_{ton}}{V_{IN1}} \times 3.12 \times 10^{-12} + 30 \times 10^{-9} \quad . \quad (4)$$

When the supply voltage is between 9 and 17.5 V, the switcher period remains constant, at a level based on the selected value of R_{ton} . At voltages lower than 9 V and higher than 17.5 V, the period is reduced by a factor of 3.5.

If a constant period is desired over varying input voltages, it is important to select an on-time that under worst case conditions will not exceed the minimum off-time or minimum on-time of the converter. For reasonable input voltage ranges, the period of the converter can be held constant, resulting in a constant operating frequency over the input supply range.

More information on how to choose R_{ton} can be found in the Application Information section.

ISEN The sense input is used to sense the current in the diode during the off-time cycle. The value for R_{SENSE} is obtained by the formula:

$$R_{SENSE} = 0.2 / I_{VALLEY} \quad , \quad (5)$$

where I_{VALLEY} is the lowest current measured through the inductor during the off-time cycle.

It is recommended that the current sense resistor be sized so that, at peak output current, the voltage on ISEN does not exceed -0.5 V. Because the diode current is measured when the inductor current is at the valley, the average output current is greater than the I_{VALLEY} value. The value for I_{VALLEY} should be:

$$I_{VALLEY} = I_{OUT(av)} - 0.5 I_{RIPPLE} + K \quad , \quad (6)$$

where:

$I_{OUT(av)}$ is the average of both output currents,

I_{RIPPLE} is the inductor ripple current, and

K is a guardband margin. The peak current in the switch is then:

$$I_{PEAK} = I_{VALLEY} + I_{RIPPLE} \quad . \quad (7)$$

The valley current must be calculated so that, at the worst-case ripple, the converter can still supply the required current to the load. Further information on how to calculate the ripple current is included in the Application Information section.

ENB An active high input enables the device. When set low, the device enters sleep mode; all internal circuitry is disabled, and the part draws a maximum of 1 μ A.

Thermal Shutdown When the device junction temperature, T_J , is sensed to be at T_{JSD} , a thermal shutdown circuit disables the regulator output, protecting the A4402 from damage.

Power-on Reset Delay The POR function monitors the V_{FB2} voltage and provides a signal that can be used to reset a DSP or microcontroller. A POR event is triggered by either of the following conditions:

- V_{FB2} falls below its UVLO threshold. This occurs if the current limit on either regulator is exceeded, or if the switcher voltage falls due to TSD.

- After a rising edge on the WDI input, the voltage on TSET reaches V_{TRIP} .

An open drain output, through the NPOR pin, is provided to signal a POR event to the DSP or microcontroller. The reset occurs after an adjustable delay, t_{POR} , set by an external capacitor connected to the POR pin. The value of t_{POR} is calculated using the following formula:

$$t_{POR} = 2.4 \times 102 \times C_{POR}, \quad (8)$$

where C_{POR} is the value of the capacitor and t_{POR} is in s.

Shutdown The buck regulator will shutdown if one of the following conditions is present:

- TSD
- ENB falling edge

Application Information

Switcher On-Time and Switching Frequency In order for the switcher to maintain regulation, the energy that is transferred to the inductor during the on-time must be transferred to the capacitor during the off-time. Because of this relationship, the load current, IR drops, as well as input and output voltages, affect the on-time of the converter. The equation that governs switcher on-time is:

$$t_{on} = \frac{T_{SW} \times (V_{SW} + R_{LOAD} \times I_{PEAK} + V_f + R_{SENSE} \times I_{PEAK})}{V_{IN1} + R_{DS(on)} \times I_{PEAK} + V_f} \quad (9)$$

The effects of the voltage drop on the inductor and trace resistance affect the switching frequency. However, the frequency variation due to these factors is small and is covered in the variation of the switcher period, T_{SW} , which is $\pm 25\%$ of the target. Removing these current dependant terms simplifies the equation:

$$t_{on} = \frac{V_{SW} + V_f + (V_{SENSE} \times I_{PEAK})}{V_{IN1} + V_f + (V_{SENSE} \times I_{PEAK})} \times \frac{1}{f_{SW}} \quad (10)$$

Be sure to use worst-case sense voltage and forward voltage of the diode, including any effects due to temperature. For example, given a 1 A converter with a supply voltage of 13.5 V, output voltage is 5 V, V_f is 0.5 V, V_{SENSE} is 0.15 V and the desired frequency is 2.0 MHz. We can solve for t_{on} as follows:

$$t_{on} = \frac{5 + 0.5 + 0.15}{13.5 + 0.5 + 0.15} \times \frac{1}{2 \times 10^6} = 199 \text{ ns}$$

The formulas above describe how t_{on} changes based on input and load conditions. Because load changes are minimal, and the output voltage is fixed, the dominant factor that affects the on-time is the input voltage. The converter is able to maintain a constant period over a varying supply voltage because the on-time change is based on the input voltage. The current into the TON terminal is derived from a resistor tied to VIN1, which sets the on-time proportional to the supply voltage. Selecting the resistor value, based on the t_{on} calculated above, is done using the following formula:

$$R_{TON} = \frac{V_{IN1} \times (t_{on} + 10 \text{ ns})}{3.12 \times 10^{-12}} \quad (11)$$

After the resistor is selected and a suitable t_{on} is found, it must be demonstrated that t_{on} does not, under worst-case conditions, exceed the minimum on-time or minimum off-time of the converter. The minimum on-time occurs at maximum input voltage and minimum load. The maximum off time is occurs at minimum supply voltage and maximum load. For supply voltages below 9.5 V and above 7 V, refer to the Low Voltage Operation section.

Low Voltage Operation The converter can run at very low input voltages. With a 5 V output, the minimum input supply can be as low as 6 V. When operating at high frequencies, the on-time of the converter must be very short because the available period is short. At high input voltages the converter must maintain very short on-times, while at low input voltages the converter must maintain long off-times. Rather than limit the supply voltage range, the converter solves this problem by automatically increasing the period by a factor of 3.5. With the period extended, the converter will not violate the minimum on-time or off-time. If the input voltage is between 9.5 V and 17 V, the converter will maintain a constant period. When calculating worst-case on-times and off-times, make sure to use the multiplier if the supply voltage is between those values.

When operating at voltages below 8 V, additional care must be taken when selecting the inductor and diode. At low voltages the maximum current may be limited due to the IR drops in the current path. When selecting external components for low voltage operation, the IR drops must be considered when determining on-time, so the complete formula should be used to make sure the converter does not violate the timing specification.

Inductor Selection Choosing the right inductor is critical to the correct operation of the switcher. The converter is capable of running at frequencies above 2 MHz. This makes it possible to use small inductor values, which reduces cost and board area.

The inductor value is what determines the ripple current. It is important to size the inductor so that under worst-case conditions I_{VALLEY} equals I_{AV} minus half the ripple current plus reasonable margin. If the ripple current is too large, the converter will be current limited. Typically peak-to-peak ripple current should be limited to 20% to 25% of the maximum average load current.

Worst-case ripple current occurs at maximum supply voltage. After calculating the duty cycle, DC, for this condition, the ripple current can be calculated. First to calculate DC:

$$DC = \frac{V_{SW} + V_f + (V_{SENSE} \times I_{PEAK})}{V_{IN1(max)} + V_f + (V_{SENSE} \times I_{PEAK})} \quad (12)$$

Using the duty cycle, a ripple current can be calculated using the following formula:

$$L = \frac{V_{IN1} - V_{SW}}{I_{RIPPLE}} \times DC \times \frac{1}{f_{SW(min)}} \quad (13)$$

where I_{RIPPLE} is 25% of the maximum load current, and $f_{SW(min)}$ is the minimum switching frequency (nominal frequency minus 25%). For the example used above, a 1 A converter with a supply voltage of 13.5 V was the design objective. The supply voltage can vary by $\pm 10\%$. The output voltage is 5 V, V_f is 0.5 V, V_{SENSE} is 0.15, and the desired frequency is 2.0 MHz. The duty cycle is calculated to be 36.45%. The worst-case frequency is 2 MHz minus 20% or 1.6 MHz. Using these numbers in the above formula shows that the minimum inductance for this converter is 9.6 μ H.

Output Capacitor The converter is designed to operate with a low-value ceramic output capacitor. When choosing a ceramic capacitor, make sure the rated voltage is at least 3 times the maximum output voltage of the converter. This is because the capacitance of a ceramic decreases as they operate closer to their rated voltage. It is recommended that the output be decoupled with a 10 μ F, X7R ceramic capacitor. Larger capacitance may be required on the outputs if load surges dramatically influence the output voltage.

Output ripple is determined by the output capacitance and the effects of ESR and ESL can be ignored assuming recommended layout techniques are followed. The output voltage ripple is approximated by:

$$V_{RIPPLE} = \frac{I_{RIPPLE}}{4 \times f_{SW} \times C_{OUT}} \quad (14)$$

Input Capacitor The value of the input capacitance affects the amount of current ripple on the input. This current ripple is usually the source of supply side EMI. The amount of interference depends on the impedance from the input capacitor and the bulk capacitance located on the supply bus. Adding a small value, 0.1 μ F, ceramic capacitor as close to the input supply pin as possible can reduce EMI effects. The small capacitor will help reduce high frequency transient currents on the supply line. If

further filtering is needed it, is recommended that two ceramic capacitors be used in parallel to further reduce emissions.

Rectification Diode The diode conducts the current during the off-cycle. A Schottky diode is needed to minimize the forward drop and switching losses. In order to size the diode correctly, it is necessary to find the average diode conduction current using the formula below:

$$I_{D(av)} = I_{LOAD} \times (1 - DC(min)) \quad (15)$$

where DC (min) is defined as:

$$DC(min) = \frac{V_{SW} + V_f}{V_{IN1} + V_f} \quad (16)$$

where V_{IN1} is the maximum input voltage and V_f is the maximum forward voltage of the diode.

Average power dissipation in the diode is:

$$P_{D(diode)} = I_{LOAD(av)} \times DC(min) \times V_f \quad (17)$$

The power dissipation in the sense resistor must also be considered using I^2R and the minimum duty cycle.

PCB Layout The board layout has a large impact on the performance of the device. It is important to isolate high current ground returns, to minimize ground bounce that could produce reference errors in the device. The method used to isolate power ground from noise sensitive circuitry is to use a star ground. This approach makes sure the high current components such as the input capacitor, output capacitor, and diode have very low impedance paths to each other. Figure 2 illustrates the technique.

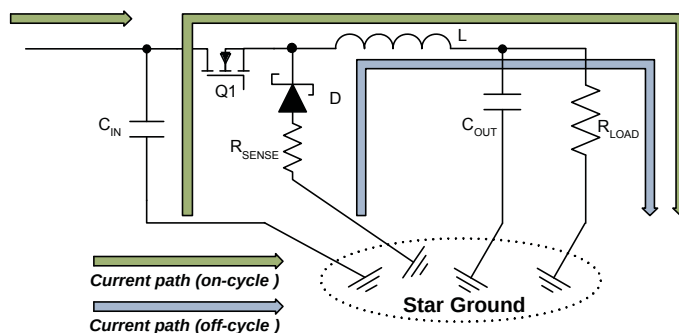


Figure 2. Star Ground Connection

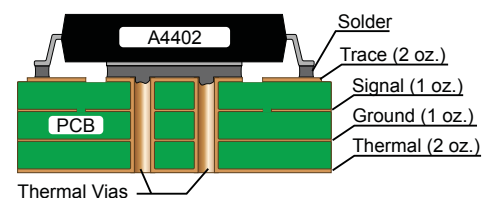
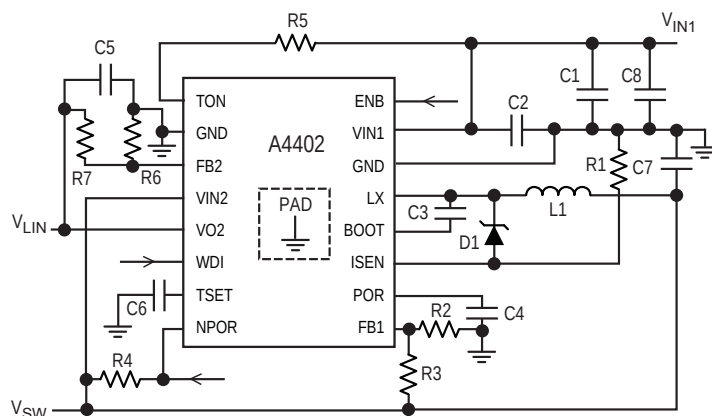
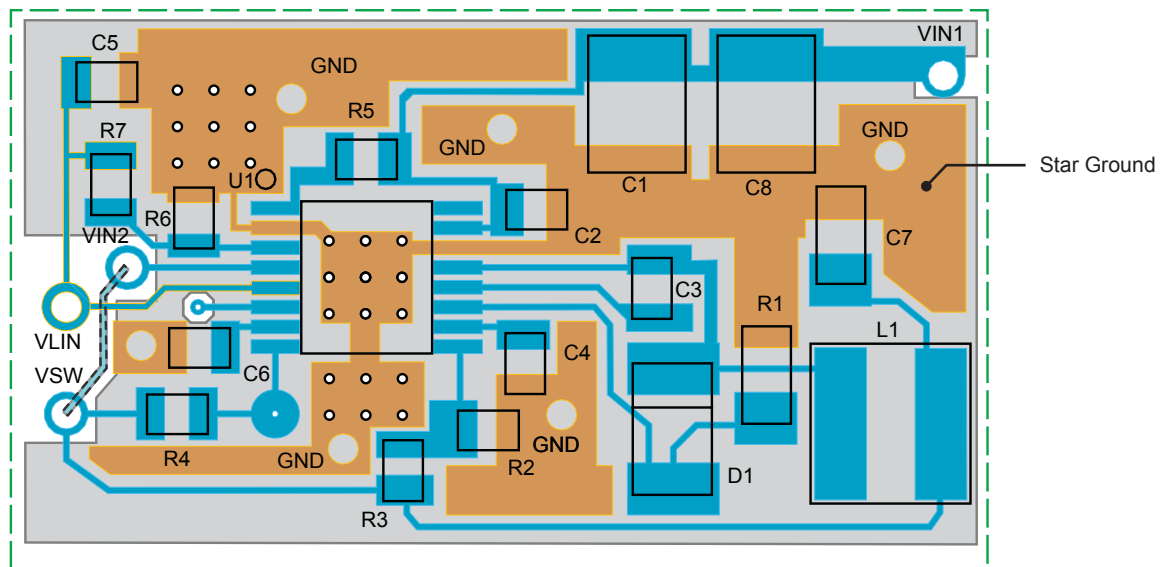
The ground from each of the components should be very close to each other and be connected on the same surface as the components. Internal ground planes should not be used for the star ground connection, as vias add impedance to the current path.

In order to further reduce noise effects on the PCB, noise sensitive traces should not be connected to internal ground planes. The feedback network from the switcher output should have an independent ground trace that goes directly to the exposed pad underneath the device. The exposed pad should be connected to internal ground planes and to any exposed copper used for heat dissipation. If the grounds from the device are also connected

directly to the exposed pad the ground reference from the feedback network will be less susceptible to noise injection or ground bounce.

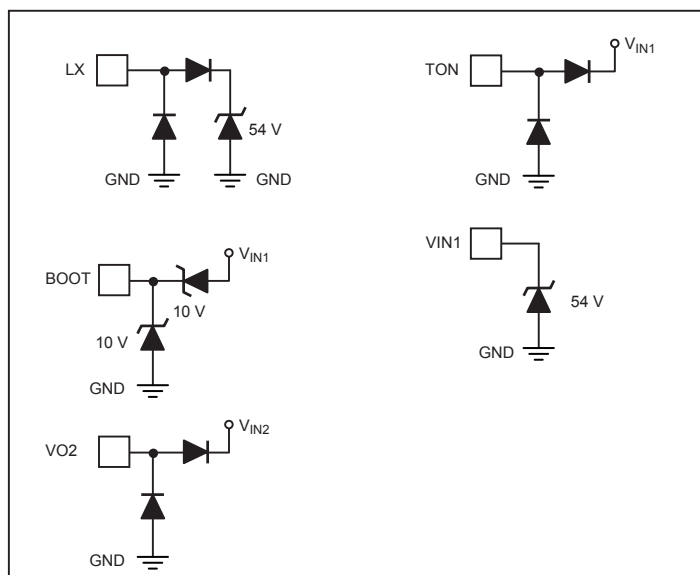
To reduce radiated emissions from the high frequency switching nodes it is important to have an internal ground plane directly under the LX node. The plane should not be broken directly under the node as the lowest impedance path back to the star ground would be directly under the signal trace. If another trace does break the return path, the energy will have to find another path, which is through radiated emissions.

PCB Layout Diagram

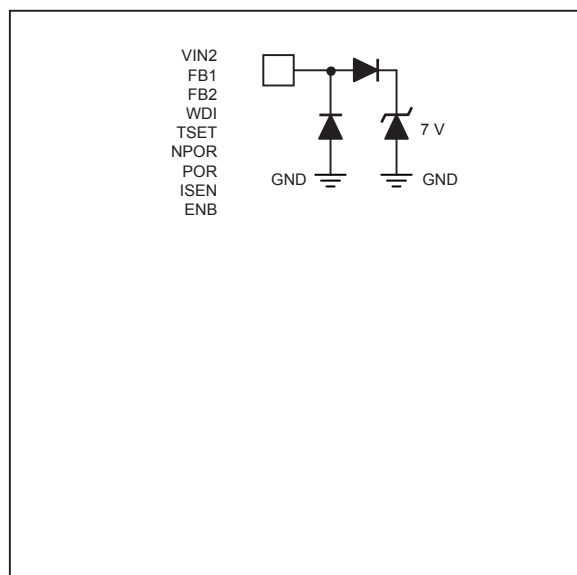


Pin Circuit Diagrams

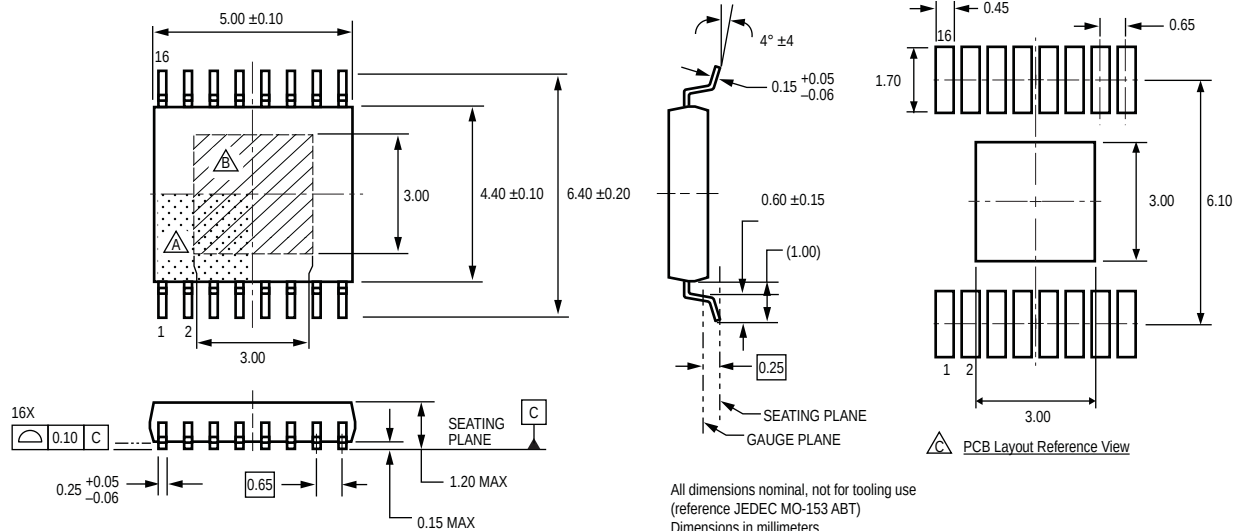
Power Terminals



Logic Terminals



Package LP, 16-Pin TSSOP



All dimensions nominal, not for tooling use
(reference JEDEC MO-153 ABT)
Dimensions in millimeters
Dimensions exclusive of mold flash, gate burrs, and dambar protrusions
Exact case and lead configuration at supplier discretion within limits shown

- △ Terminal #1 mark area
- △ Exposed thermal pad (bottom surface)
- △ Reference land pattern layout (reference IPC7351 SOP65P640X110-17M); All pads a minimum of 0.20 mm from all adjacent pads; adjust as necessary to meet application process requirements and PCB layout tolerances; when mounting on a multilayer PCB, thermal vias at the exposed thermal pad land can improve thermal dissipation (reference EIA/JEDEC Standard JESD51-5)

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Allegro MicroSystems, Inc.
115 Northeast Cutoff
Worcester, Massachusetts 01615-0036 U.S.A.
1.508.853.5000; www.allegromicro.com